

PCB SPECIFICATION

Layers	2 layers
Material	FR-4
FR4-TG	TG 130
Thickness	1.0mm
Min Track/Spacing	6mil
Min Hole Size	0.3mm
Solder Mask	Green
Silkscreen	White
Surface Finish	HASL with lead or OSP
Via Process	Tenting via
Finished Copper	10z

Drill Table

Symbol	Count	Hole Size	Plated	Hole Tolerance
¢	57	0.30mm	Plated	
	6	0.90mm	Plated	
\Diamond	2	2.00mm	Non-Plated	
X	2	3.00mm	Non-Plated	
0	1	3.50mm	Non-Plated	
	68 Total			